

## Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted

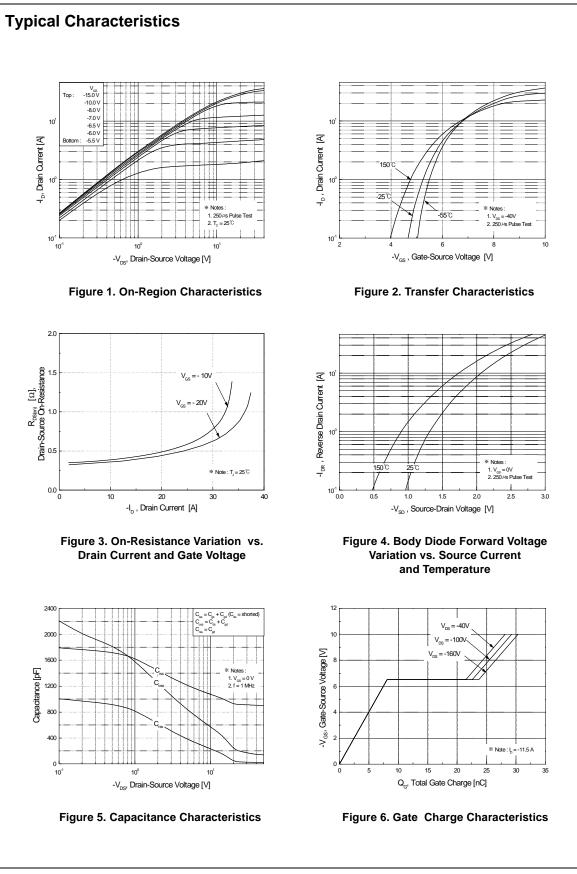
Symbol	Parameter		FQB12P20 / FQI12P20	Units
V <sub>DSS</sub>	Drain-Source Voltage		-200	V
I <sub>D</sub>	Drain Current - Continuous ( $T_c = 25^{\circ}C$ )		-11.5	А
	- Continuous (T <sub>C</sub> = 100°C)		-7.27	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	-46	А
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	810	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	-11.5	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	12	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-5.5	V/ns
P <sub>D</sub>	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.13	W
	Power Dissipation ( $T_c = 25^{\circ}C$ )		120	W
	- Derate above 25°C		0.96	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

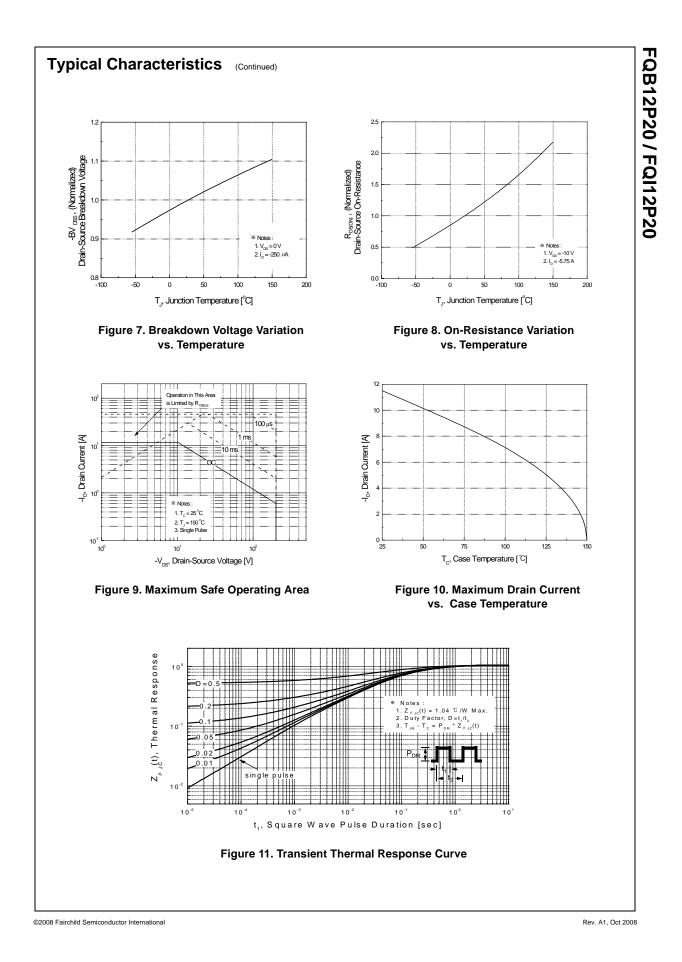
## **Thermal Characteristics**

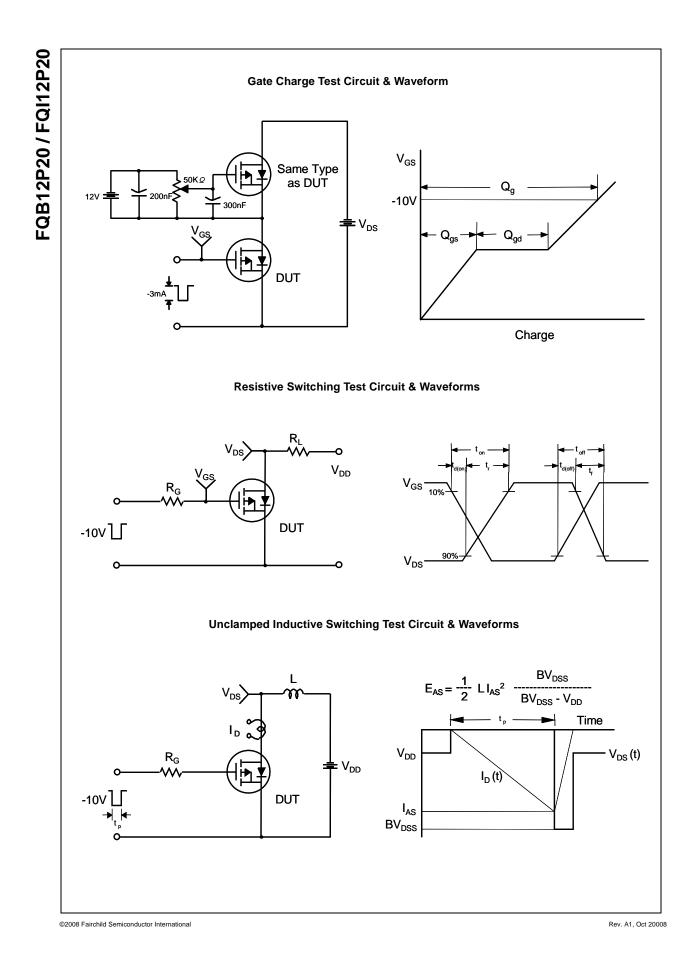
Symbol	Parameter	Тур	Max	Units
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case		1.04	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

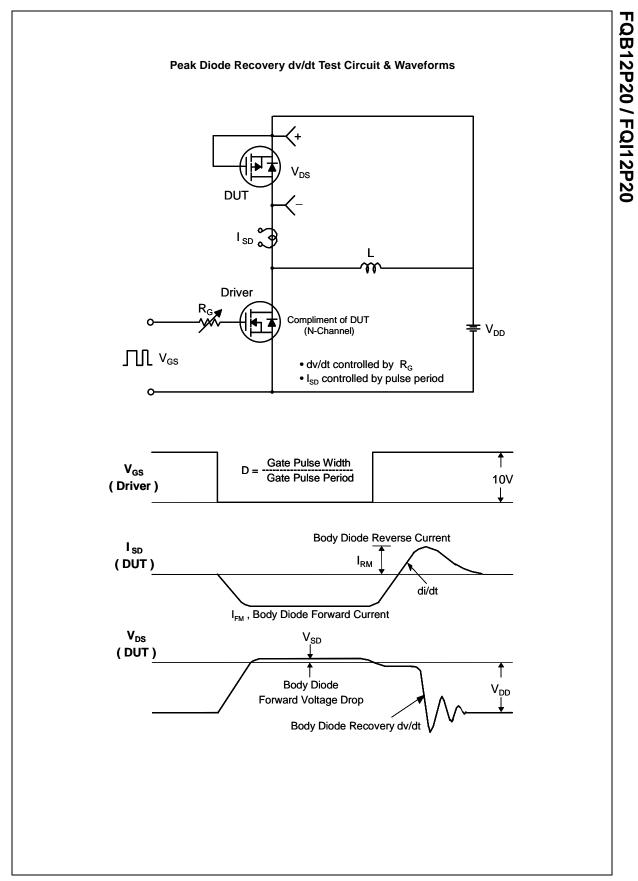
Off Cha	Parameter	Test Conditions	Min	Тур	Max	Units
BV <sub>DSS</sub>	ractariation					
W D O O	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-200			V
BV <sub>DSS</sub>	Breakdown Voltage Temperature					v
$\Delta T_{J}$	Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-		V/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μA
	Zero Gale Voltage Drain Current	V <sub>DS</sub> = -160 V, T <sub>C</sub> = 125°C			-10	μΑ
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
)n Cha	racteristics					
GS(th)	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-3.0		-5.0	V
R <sub>DS(on)</sub>	Static Drain-Source					
20(01)	On-Resistance	$V_{GS}$ = -10 V, $I_{D}$ = -5.75 A		0.36	0.47	Ω
IFS	Forward Transconductance	$V_{DS} = -40 \text{ V}, \text{ I}_{D} = -5.75 \text{ A}$ (Note 4)		6.4		S
)vnami	c Characteristics					
viss	Input Capacitance	N 05 X X 0 X		920	1200	pF
oss	Output Capacitance	V <sub>DS</sub> = -25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		190	250	pF
rss	Reverse Transfer Capacitance	1 = 1.0 MHz		30	40	pF
155				00	40	Р
witchi	ng Characteristics					
	ng Characteristics Turn-On Delay Time	)/ _ 100)/ I _ 11.5 A		20	50	ns
d(on)	•	$V_{DD} = -100 \text{ V}, \text{ I}_{D} = -11.5 \text{ A},$		20 195	50 400	ns ns
	Turn-On Delay Time	$V_{DD}$ = -100 V, I <sub>D</sub> = -11.5 A, R <sub>G</sub> = 25 Ω				
d(on)	Turn-On Delay Time Turn-On Rise Time			195	400	ns
d(on) - d(off)	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time	R <sub>G</sub> = 25 Ω (Note 4, 5)		195 40	400 90	ns ns
d(on) d(off)	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	$R_{G} = 25 \Omega$ (Note 4, 5) V <sub>DS</sub> = -160 V, I <sub>D</sub> = -11.5 A,		195 40 60	400 90 130	ns ns ns
d(on) - d(off)	Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge	R <sub>G</sub> = 25 Ω (Note 4, 5)	  	195 40 60 31	400 90 130 40	ns ns ns nC
d(on) d(off) 2 <sub>g</sub> 2 <sub>gs</sub> 2 <sub>gd</sub> Drain-S	Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge	$R_{G} = 25 Ω$ (Note 4, 5) $V_{DS} = -160 V, I_{D} = -11.5 A,$ $V_{GS} = -10 V$ (Note 4, 5) (Note 4, 5)	   	195 40 60 31 8.1	400 90 130 40 	ns ns nC nC nC
d(on) d(off) ag Ag Ags Agd Drain-So S	Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge         Gate-Drain Charge         ource Diode Characteristics ar	$R_{G} = 25 \Omega$ (Note 4, 5) $V_{DS} = -160 V, I_{D} = -11.5 A,$ $V_{GS} = -10 V$ (Note 4, 5) (Note 4,	   	195         40         60         31         8.1         16	400 90 130 40  	ns ns nC nC nC A
d(on) d(off) d(off) dgg Qgs Qgs Qgd Drain-So SM	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge <b>ource Diode Characteristics ar</b> Maximum Continuous Drain-Source Diode F	$R_{G} = 25 \Omega$ (Note 4, 5) $V_{DS} = -160 V, I_{D} = -11.5 A,$ $V_{GS} = -10 V$ (Note 4, 5) (Note 4,	     	195 40 60 31 8.1 16	400 90 130 40   -11.5 -46	ns ns nC nC nC A A
d(on) d(off) ag Ag Ags Agd Drain-So S	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge ource Diode Characteristics ar Maximum Continuous Drain-Source Dio	$R_{G} = 25 \Omega$ (Note 4, 5) $V_{DS} = -160 V, I_{D} = -11.5 A,$ $V_{GS} = -10 V$ (Note 4, 5) (Note 4,	     	195 40 60 31 8.1 16  	400 90 130 40  	ns ns nC nC nC A

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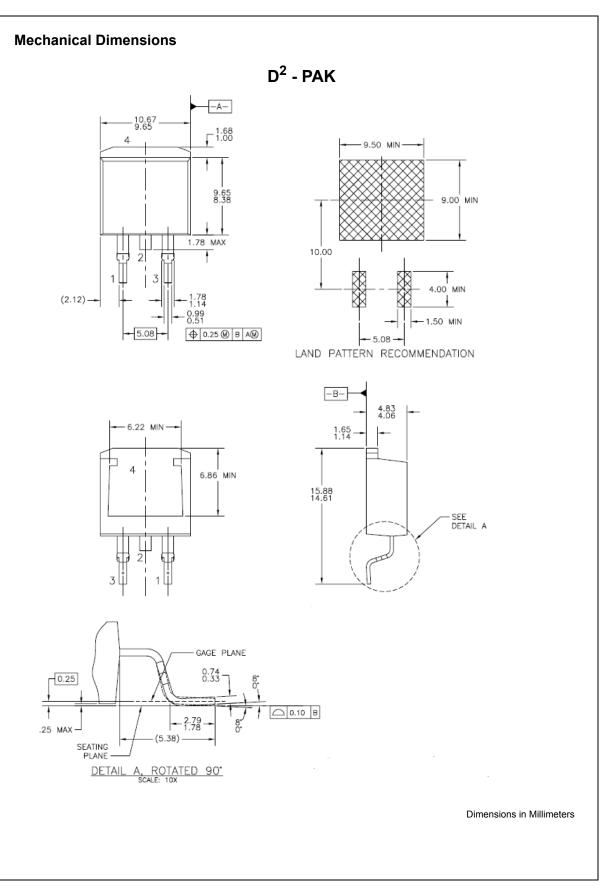


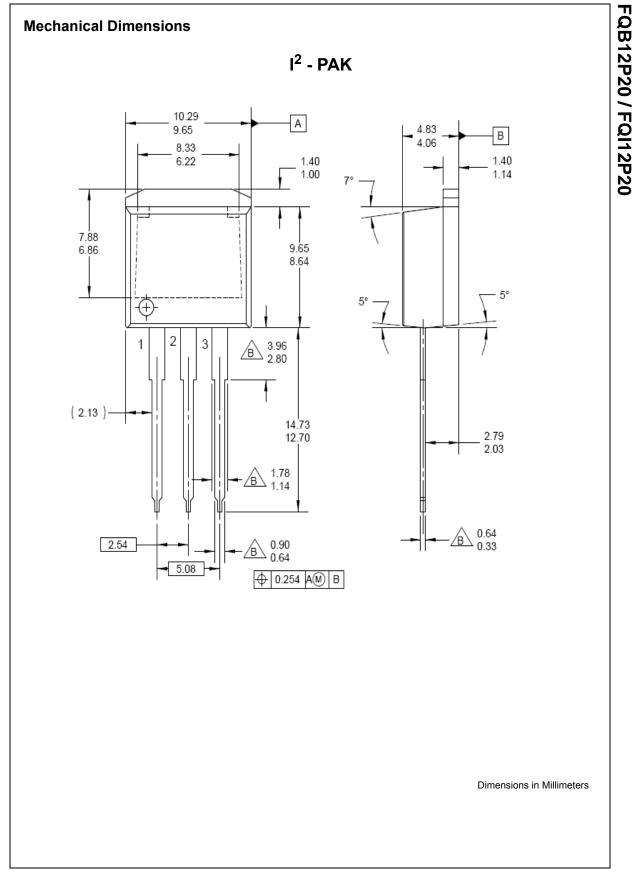


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